PATENT

TESSERA 3.0-022

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of

Karavakis, et al

Serial No. 08/246,113

Filed: May 19, 1994

For: METHOD OF ENCAPSULATING

DIE AND CHIP CARRIER

Group Art Unit 1208

Examiner: R. Lovering

Batch No. J09

Dated: April 14, 1997

Assistant Commissioner For Patents Washington, D.C. 20231 RECEIVED
Publishing Division
APR 1 6 1997

TRANSMITTAL OF FORMAL DRAWINGS

sir:

Enclosed herewith are five (5) sheets of formal drawings for filing in connection with the above-identified application. The formal drawings are submitted in order to correct the informalities listed in form PTO-948.

In the event there are any fees due and owing in connection with this matter, please charge same to our Deposit Account No. 12-1095.

Respectfully submitted,

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I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class mail in an envelope addressed to Assistant Commissioner for Patents, Washington, D.C. 20231 on April 14, 1997.

(Signature)

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